

Applicant: Daewoong Suh

Examiner: Jonathan Johnson

Serial No.: 10/808,192

Group Art Unit: 1725

Filed: March 24, 2004

Docket No.: 884.C25US1

Title: SOLDERING AN ELECTRONICS PACKAGE TO A MOTHERBOARD

Customer Number: 21186

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

This paper responds to the Office Action mailed on November 14, 2006. Please amend the above-identified patent application as follows.